

N-Channel 80-V (D-S) Super Trench Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V)	$R_{DS(on)}$ (Ω) MAX.	I _D (A)	Q _g (TYP.)		
80	0.0034 at V _{GS} = 10 V	195	75nC		
	0.0036 at V _{GS} = 7.5 V	185	75110		



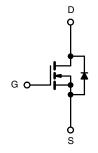
FEATURES

- Super Trench technology Power MOSFET
- Excellent gate charge x Rds (on) product(FOM)
- Very low on-resfistance Rds (on)
- \bullet 100 % R_g and UIS Tested



APPLICATIONS

- Power supply
 - Secondary synchronous rectification
- DC/DC converter
- Power tools
- · Motor drive switch
- DC/AC inverter
- Battery management



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	LIMIT	UNIT			
Drain-Source Voltage	V _{DS}	80	V			
Gate-Source Voltage		V _{GS}	V _{GS} ± 20			
Ocalia de Burio Ocardo (T., 450.00)	T _C = 25 °C	,	195			
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	120 ^d			
Pulsed Drain Current (t = 100 μs)	I _{DM}	600	A			
Avalanche Current		I _{AS}	70			
Single Avalanche Energy ^a	L = 0.1 mH	E _{AS}	245	mJ		
Mariana Baran Biratadia 8	T _C = 25 °C	В	375 b	W		
Maximum Power Dissipation ^a	T _C = 125 °C	P _D	125 ^b			
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	LIMIT	UNIT		
Junction-to-Ambient (PCB Mount) ^c	R_{thJA}	40	°C/W		
Junction-to-Case (Drain)	R _{thJC}	0.4	C/VV		

Notes

- a. Duty cycle \leq 1 %.
- b. See SOA curve for voltage derating.
- c. When mounted on 1" square PCB (FR4 material).
- d. Package limited.



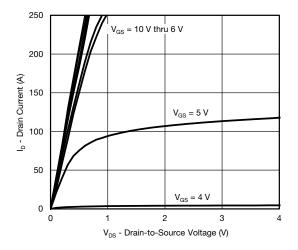
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
Static			•				
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	80	-	-	V	
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2	-	4		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	-	-	± 250	nA	
		V _{DS} = 80 V, V _{GS} = 0 V	-	1	1		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 80 V, V _{GS} = 0 V, T _J = 125 °C	-	-	150	μA	
		V _{DS} = 80 V, V _{GS} = 0 V, T _J = 175 °C	-	-	5	mA	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 10 \text{ V}, V_{GS} = 10 \text{ V}$	120	-	-	Α	
Durin Course On Chata Basistana 2	Б	V _{GS} = 10 V, I _D = 30 A	-	0.0028	0.0034	Ω	
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 7.5 V, I _D = 20 A	-	0.0030	0.0036		
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 30 A	-	82	-	S	
Dynamic ^b			•				
Input Capacitance	C _{iss}		-	-	6300	pF	
Output Capacitance	C _{oss}	V _{GS} = 0 V, V _{DS} = 40 V, f = 1 MHz	-	-	1200		
Reverse Transfer Capacitance	C _{rss}		-	-	105		
Total Gate Charge ^c	Qg		-	75	102	nC	
Gate-Source Charge ^c	Q _{gs}	$V_{DS} = 40 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$	-	20	28		
Gate-Drain Charge ^c	Q_{gd}		-	8	14		
Gate Resistance	R_g	f = 1 MHz	0.28	1.4	2.8	Ω	
Turn-On Delay Time ^c	t _{d(on)}		-	24	40		
Rise Time ^c	t _r	$V_{DD} = 40 \text{ V}, R_L = 4 \Omega$	-	24	40		
Turn-Off Delay Time ^c	t _{d(off)}	$I_D\cong 10~A,~V_{GEN}=10~V,~R_g=1~\Omega$	-	34	60	ns	
Fall Time ^c	t _f		-	14	28		
Drain-Source Body Diode Ratings ar	nd Characteris	stics ^b (T _C = 25 °C)	•				
Pulsed Current (t = 100 μs)	I _{SM}		-	-	250	Α	
Forward Voltage ^a	V _{SD}	I _F = 10 A, V _{GS} = 0 V	-	0.8	1.5	٧	
Reverse Recovery Time	t _{rr}		-	126	190	ns	
Peak Reverse Recovery Charge	I _{RM(REC)}	$I_F = 34 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}$	-	5	10	Α	
Reverse Recovery Charge	Q _{rr}		_	0.315	0.475	μC	

Notes

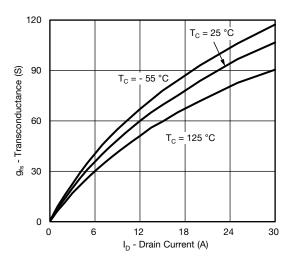
- a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing. c. Independent of operating temperature.



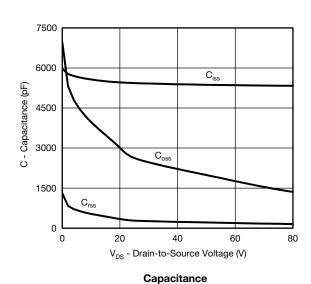
TYPICAL CHARACTERISTICS ($T_A = 25$ °C, unless otherwise noted)

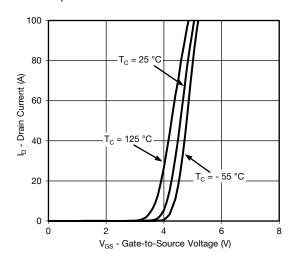


Output Characteristics

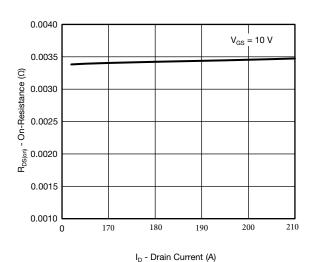


Transconductance

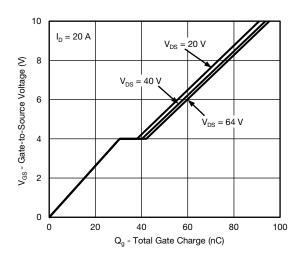




Transfer Characteristics



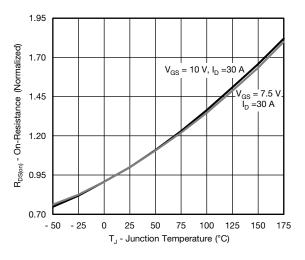
On-Resistance vs. Drain Current



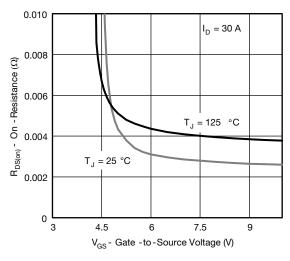
Gate Charge



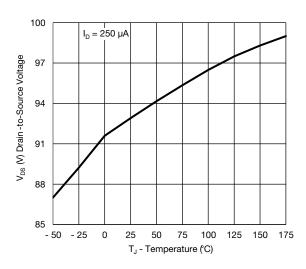
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



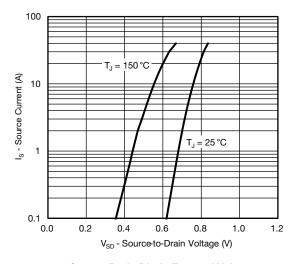
On-Resistance vs. Junction Temperature



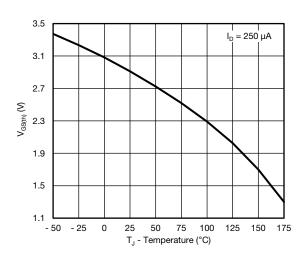
On-Resistance vs. Gate-to-Source Voltage



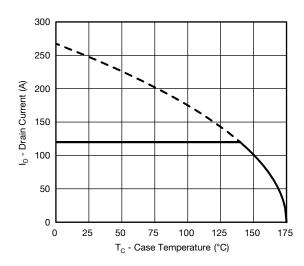
Drain Source Breakdown vs. Junction Temperature



Source Drain Diode Forward Voltage



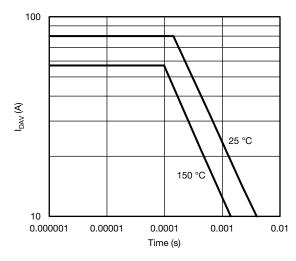
Threshold Voltage



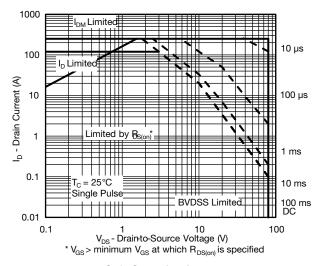
Current De-rating



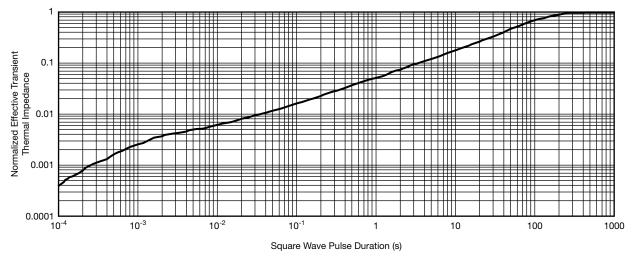
THERMAL RATINGS ($T_A = 25$ °C, unless otherwise noted)



Single Pulse Avalanche Current Capability vs. Time



Safe Operating Area

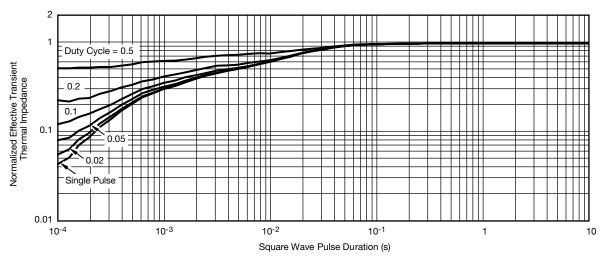


Normalized Thermal Transient Impedance, Junction-to-Ambient

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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



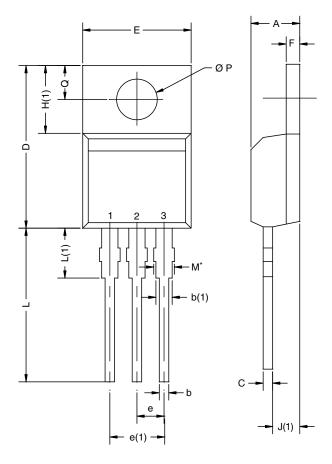
Normalized Thermal Transient Impedance, Junction-to-Case

Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction to Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction to Case (25 °C) are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions.



TO-220AB



	<u> </u>
	D2

	MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.25	4.65	0.167	0.183
b	0.69	1.01	0.027	0.040
b(1)	1.20	1.73	0.047	0.068
С	0.36	0.61	0.014	0.024
D	14.85	15.49	0.585	0.610
D2	12.19	12.70	0.480	0.500
Е	10.04	10.51	0.395	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.09	6.48	0.240	0.255
J(1)	2.41	2.92	0.095	0.115
L	13.35	14.02	0.526	0.552
L(1)	3.32	3.82	0.131	0.150
ØΡ	3.54	3.94	0.139	0.155
Q	2.60	3.00	0.102	0.118
ECN: T14-0413-Rev. P, 16-Jun-14 DWG: 5471				

Note

 $^{^{\}star}$ M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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